

Android™ Release Notes

Contents

1 Release Description

The i.MX Android™ 08.0.0_1.3.0_8M-PRC release is a PRC/Beta release for the Android 8.0 Oreo (O) platform on the i.MX 8MQuad EVK board applications processors.

i.MX Android 08.0.0_1.3.0_8M-PRC release includes all necessary code, documents, and tools to assist users in building and running the Android 8.0 platform on the i.MX 8MQuad EVK board from scratch. Pre-built images are also included for a quick trial on the following platform:

- i.MX 8MQuad EVK Board and Platform

This release includes all porting and enhancements based on the Android open source code.

Most of the deliveries in this release are provided in source code with the exception of some proprietary modules/libraries from third parties.

2 Supported Hardware SoC/Boards

The supported hardware system-on-chip (SoCs)/boards are listed as follows:

- i.MX 8MQuad EVK Board and Platform

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3 Release Package Contents

The O8.0.0_1.3.0_8M-PRC release package includes the following software and documents.

Table 1. Release package contents

i.MX Android proprietary source code package	<ul style="list-style-type: none"> imx-o8.0.0_1.3.0_8mq-prc.tar.gz: i.MX Android proprietary source code package to enable the Android platform on i.MX boards.
Documents	<p>The following documents are included in android_O8.0.0_1.3.0_8M-PRC_docs.tar.gz</p> <ul style="list-style-type: none"> <i>Android™ Quick Start Guide (AQSUG)</i>: A document that explains how to run the Android platform on an i.MX board using prebuilt images. <i>Android™ User's Guide (AUG)</i>: A document describing procedures for configuring and building this release package. <i>Android™ Release Notes (ARN)</i>: A document that introduces key updates and known issues in this release. <i>i.MX Android™ Extended Codec Release Notes (IMXACRN)</i>: A document that provides the extended codec information. <i>Android™ Frequently Asked Questions (FAQ)</i>: A document that contains the answers to the Frequently Asked Questions (FAQs). <i>i.MX Graphics User's Guide (IMXGRAPHICUG)</i>: A document that describes GPU 2D API, Tools, Memory, and Application programming guidelines.
Tools	<p>Tools in android_O8.0.0_1.3.0_8M-PRC_tools.tar.gz</p> <ul style="list-style-type: none"> VivanteVTK-v6.2.4.1.7.4.tgz: GPU tools for Vivante GPU 6.2.4 driver. For more information about these tools, see <i>i.MX Graphics User's Guide (IMXGRAPHICUG)</i>. fsl-sdcard-partition.sh: tool to make partition and flash Android images. MFGTool: Manufacturing tools for i.MX platform.
Prebuilt images	<p>You can test the Android platform with a prebuilt image on i.MX reference board before building any code:</p> <ul style="list-style-type: none"> android_O8.0.0_1.3.0_8M-PRC_image_8mq.tar.gz: Prebuilt images with NXP extended features for the i.MX 8MQuad EVK board. The extended features include more multimedia format support. <p>All prebuilt images are in a separate package. See the <i>Android™ Quick Start Guide (AQSUG)</i> and <i>Android™ User's Guide (AUG)</i> to choose the appropriate image.</p>

4 Features

This section contains features in this package.

Table 2. Features

Feature	i.MX 8MQuad EVK	Remarks
Linux 4.9.68 kernel (merged with the AOSP kernel)	Y	Based on Linux® OS BSP L4.9.51_imx8mq-beta release
Google Oreo 8.0 release	Y	Based on android-8.0.0_r25
Boot source	SD/eMMC	-
Splash Screen for LVDS	N	-

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Table 2. Features (continued)

Feature	i.MX 8MQuad EVK	Remarks
UI (input)	N	-
UI (display)	HDMI/MIPI Display	-
UI (dual display, LVDS+HDMI, UI mirror displayed on second device)	N	-
UI (brightness control)	N	-
Storage - External Media	Y	Supports the udisk on the USB host port
Connectivity - Ethernet	Y	-
Connectivity - Bluetooth® wireless technology	Y	Hardware: <ul style="list-style-type: none"> • QCOM 1CQ qca6174A Profiles: <ul style="list-style-type: none"> • A2DP Source • BLE Host
Connectivity - Wi-Fi	Y	Hardware: <ul style="list-style-type: none"> • QCOM 1CQ qca6174A Features: <ul style="list-style-type: none"> • AP mode
Connectivity - USB Tethering	Y	-
Power - CPU Freq	Y	-
Power - Bus Freq	Y	-
Media - Music Play	Y	SSI + WM8524
Media - Video Play	Y	-
Media - Camera	Y	OV5640. Camera cannot co-work with MIPI Display due to the I2C address conflict.
Media - TVIN	N/A	PAL/NTSC
Media - Dual Camera	N	-
Media - Camcorder	N	-
Media - USB Camera	N	-
Media - USB Mic	Y	-
Media - HDMI audio output	Y	-
Graphic - HW 3D acceleration	Y	OpenGL ES1.1/2.0/3.1 through GC7000L
Graphic - HW accelerated UI surface composition	Y	-
Misc - ADB over USB	Y	-
Misc - Fastboot utility	Y	-
Misc - SW update and factory reset	Y	-
Sensor - Magnetometer	N	-
Sensor - Accelerometer	N	-
Sensor - Gyroscope	N	-
Sensor - Light	N	-

Table continues on the next page...

Table 2. Features (continued)

Feature	i.MX 8MQuad EVK	Remarks
Sensor - Pressure	N	-
Sensor - Temperature	N	-
Data Partition Encryption	Y	-
USB Accessory	Y	Google AOA v2.0
Screen Recording	Y	-
Ethernet APK	Y	-
webGL	Y	-
OTA for A/B	Y	-
USB TYPEC PD	Y	Supports power role switch with device that supports USB power delivery

5 Multimedia Codecs

For multimedia codecs and features, see Section 5 in the [Android 8.0 Compatibility Definition Document\(CDD\)](#).

6 Extended Feature Packages

The release extends the default AOSP Android version with the following features. For more information about the features below, contact "L2manager-android@nxp.com". For detailed extended and additional features, see *i.MX Android™ Extended Codec Release Notes* (IMXACRN).

7 Change Logs

Compared to the N7.1.2_2.1.0_8MQ-EAR release, this release has the following major changes:

- Upgraded the kernel from v4.9.11 to v4.9.68.
- Enabled A/B slot for the Android system.
- Upgraded the Android code base from android-7.1.2_r9 to android-8.0.0_r25.
- Upgraded the GPU driver from 6.2.2 to 6.2.4.
- Enabled DRM-based gralloc and EGL.
- MIPI display support.
- Enabled USB typec power role switch.
- Enabled Bluetooth with QCOM ICQ module.

8 Known Issues and Limitations

The known issues about the hardware and hardware rework instructions are not included in this document. There may be hardware-related reference materials for some reference boards. Make sure to check the link [i.MX Application Processors](#) to see if it is applicable.

Table 3. Known issues and limitations

Issue description	Remarks
The Google USB driver must be installed multiple times for the MTP, PTP, MTP&ADB, PTP&ADB, and ADB function settings.	Some Windows XP environments may display MTP and PTP windows even with only PTP enabled in the device.
The media audio can only be accessed by the HDMI monitor when a physical HDMI display is used.	On-board headphone jack cannot detect whether the headphone is inserted. The audio jack is treated as a speaker. For media sound, HDMI output has higher priority than speaker, and all media sounds route to HDMI.
Bluetooth is not enabled in the default prebuilt image for i.MX 8MQuad EVK.	<ul style="list-style-type: none"> To enable Bluetooth, request the wcnss_filter binary from Qualcomm.

9 Revision History

Table 4. Revision history

Revision number	Date	Substantive changes
N7.1.2_2.1.0_8MQ-EAR	09/2017	Initial release
O8.0.0_1.3.0_8M-PRC	01/2018	i.MX 8MQuad PRC release

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Document Number: ARN
Rev. 08.0.0_1.3.0_8M-PRC
01/2018

